MSKSEMI















ESD

TVS

TSS

MOV

GDT

PLED

Broduct data sheet



- Ultra low leakage: nA level
- Operating voltage: 5V
- Low clamping voltage
- Complies with following standards:
 - IEC 61000-4-2 (ESD) immunity test

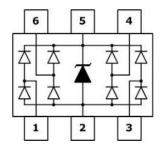
Air discharge: ±15kV Contact discharge: ±10kV

- IEC61000-4-4 (EFT) 40A (5/50ns)
- IEC61000-4-5 (Lightning) 5A (8/20 μs)
- RoHS Compliant



SOT-23-6

Pin Config uration



Applications

- USB 2.0 power and data line
- Set-top box and digital TV
- Digital video interface (DVI)
- Notebook Computers
- SIM Ports

Mechanical Characteristics

• Package: SOT-23-6

Lead Finish: Lead Free

- UL Flammability Classification Rating 94V-0
- Quantity Per Reel:3,000pcs
- Reel Size:7inch

Absolute Maximum Ratings(Tamb=25°C unless otherwise specified)

Parameter	Symbol	Value	Unit	
Peak Pulse Power (8/20µs)	Ррр	80	W	
ESD per IEC 61000-4-2 (Air)	V _{ESD}	±15	Kv	
ESD per IEC 61000-4-2 (Contact)	VESD	±10	r\v	
Operating Temperature Range	TJ	-55 to +125	\mathbb{C}	
Storage Temperature Range	T _{STJ}	-55 to +150	$^{\circ}$	

Electrical Characteristics(TA=25°C unless otherwise specified)

P/N	V _{RWM} (V)	V _{BR} (V)	I _⊤ (mA)	V _c @1A	(Max)	(@A)	I _R μΑ (Max)	C (Pf) (Typ.)
RCLAMP0504S-MS	5	6	1	12	16	5	1	0.6

Characteristic Curves

Fig1. $8/20\mu$ s Pulse Waveform

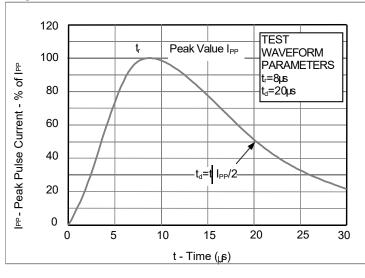


Fig2. ESD Pulse Waveform (according to IEC 61000-4-2)

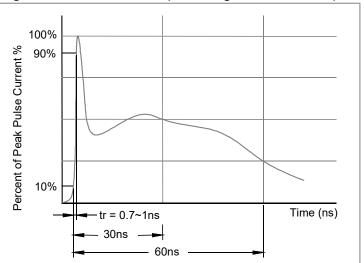
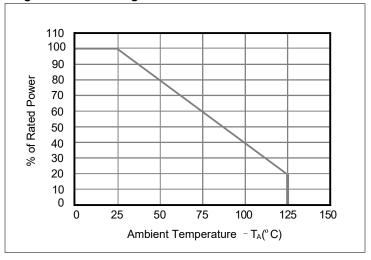
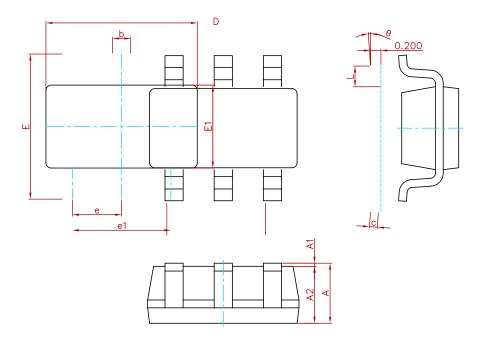


Fig3. Power Derating Curve

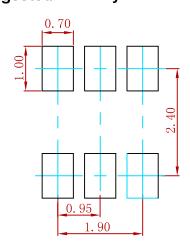


PACKAGE MECHANICAL DATA



Symbol	Dimensions In	n Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
Α	1.050	1.250	0.041	0.049	
A1	0.000	0.100	0.000	0.004	
A2	1.050	1.150	0.041	0.045	
b	0.300	0.500	0.012	0.020	
С	0.100	0.200	0.004	0.008	
D	2.820	3.020	0.111	0.119	
E1	1.500	1.700	0.059	0.067	
Е	2.650	2.950	0.104	0.116	
е	0.950(BSC)	0.037	(BSC)	
e1	1.800	2.000	0.071	0.079	
L	0.300	0.600	0.012	0.024	
θ	0°	8°	0°	8°	

Suggested Pad Layout



Note:

- 1.Controlling dimension:in millimeters. 2.General tolerance:± 0.05mm.
- 3. The pad layout is for reference purposes only.

REEL SPECIFICATION

P/N	PKG	QTY
RCLAMP0504S-MS	SOT-23-6	3000



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